

Features

Maximum output current is 1.2A

Range of operation input voltage: Max 15V

• Line regulation: 0.03%/V (typ.)

Standby current: 2mA (typ.)

• Load regulation: 0.2%/A (typ.)

● Environment Temperature: -20°C~85°C

Applications

 Power Management for Computer Mother Board, Graphic Card

LCD Monitor and LCD TV

- DVD Decode Board
- ADSL Modem
- Post Regulators For Switching Supplies

General Description

TX1117C is a series of low dropout three-terminal regulators with a dropout of 1.3V at 800mA load current. TX1117C features a very low standby current 2mA compared to 5mA of competitor.

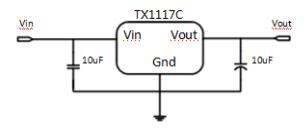
Other than a fixed version, Vout = 1.2V, 1.8V, 2.5V, 2.85V, 3.3V, and 5V, TX1117C has an adjustable version, which can provide an output voltage from 1.25 to 12V with only

two external resistors.

TX1117C offers thermal shut down function, to assure the stability of chip and power system. And it uses trimming technique to guarantee output voltage accuracy within 2%. Other output voltage accuracy can be customized on demand, such as 1%.

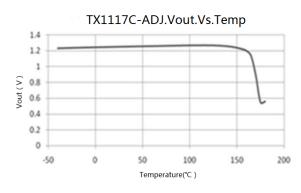
TX1117C is available in SOT-223, TO-252 power package.

Typical Application



Application circuit of TX1117C fixed version

Typical Electrical Characteristic



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Selection Table

Marking	Part No.	Output Voltage	Package
	XX=12	1.2V	
	XX=18	1.8V	
1117 C	XX=28	2.85V	COT 222
XX YYWW	XX=25	2.5V	SOT-223 TO-252
	XX=33	3.3V	10-252
	XX=50	5.0V	
	XX=AD	Adj	

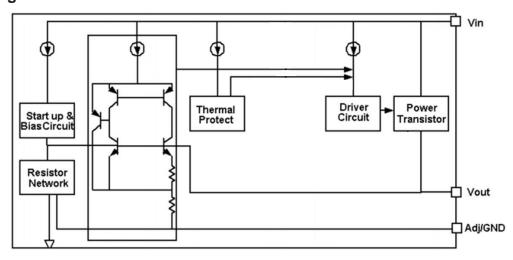
Ordering Information

Marking	Designator	Description
1117 C XX YYWW	1117 C	Product code
	XX	Output Voltage(1.2~12.0V)
	YYWW	DATE CODE

 $\label{eq:continuous} \textbf{Note:} "XX" \ \text{stands for output voltages. Other voltages can be specially customized}$

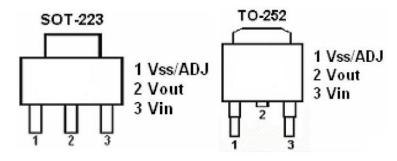
Parameters	Description	
Temperature & Rohs	C:-40~85℃ ,Pb Free Rohs Std.	
Package type	L:SOT-223	
	O:TO-252	
Packing type:	TR: Tape & Reel (Standard)	
Voltage accuracy	2%(Customized)	

Block Diagram





Pin Configuration



Absolute Maximum Ratings

Max Input Voltage ·····	· · · 30V
Max Operating Junction Temperature(Tj)	· ··150℃
Ambient Temperature(Ta) · · · · · · · · · · · · · · · · · · ·	· ··-40°C~ 85°C
Storage Temperature(Ts)	· · · -40°C~150°C
Lead Temperature & Time	260°C 10S

Caution: Exceed these limits to damage to the device. Exposure to absolute maximum rating conditions may affect device reliability.

Recommended Work Conditions

Recommended maximum input voltage	15V
Recommended operating junction temperature(Tj)	-20~125°C

Thermal Information

Parameter	Package	Rating	Unit
Package thermal resistance	SOT-223	20	°C/W
	TO-252	12.5	°C/W



Electrical Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Vref	Reference	TX1117C-Adj	1.225	1.25	1.275	V
voltage		10mA≤lout≤800mA , Vin=3.25V				
		TX1117C-1.2V	1.176	1.2	1.224	V
		0≤lout≤800mA , Vin=3.2V				
		TX1117C-1.8V	1.764	1.8	1.836	V
		0≤lout≤800mA , Vin=3.8V				
		TX1117C-2.5V	2.45	2.5	2.55	V
Vout	Output voltage	0≤lout≤800mA , Vin=4.5V				
		TX1117C-2.85V	2.793	2.85	2.907	V
		0≲Iout≲800mA , Vin=4.85V				
		TX1117C-3.3V	3.234	3.3	3.366	V
		0≤lout≤800mA , Vin=5.3V				
		TX1117C-5.0V	4.9	5	5.1	V
		0≤lout≤800mA , Vin=7.0V				
						•
		TX1117C-1.2V		0.03	0.2	%/V
		lout=10mA, 2.7V≲Vin≤10V				
	Line	TX1117C-ADJ		0.03	0.2	%/V
		lout=10mA, 2.75V≪Vin≪12V				
		TX1117C-1.8V		0.03	0.2	%/V
		lout=10mA, 3.3V≲Vin≤12V				
$\triangle Vout$		TX1117C-2.5V		0.03	0.2	%/V
	regulation	lout=10mA, 4.0V≲Vin≤12V				
		TX1117C-2.85V		0.03	0.2	%/V
		lout=10mA, 4.35V≲Vin≤12V				
		TX1117C-3.3V		0.03	0.2	%/V
		lout=10mA, 4.8V≲Vin≤12V				
		TX1117C-5.0V		0.03	0.2	%/V
		lout=10mA, 6.5V≲Vin≤12V				
•						•
		TX1117C-1.2V		2	8	mV
		Vin =2.7V, 10mA≤lout≤800mA				
		TX1117C-ADJ		2	8	mV
		Vin =2.75V, 10mA≤lout≤800mA				
		TX1117C-1.8V		3	12	mV
		Vin =3.3V, 10mA≤lout≤800mA				



△Vout	Load	TX1117C-2.5V	4	16	mV
	regulation	Vin =4.0V, 10mA≤lout≤800mA			
		TX1117C-2.85V	5	20	mV
		Vin =4.35V, 10mA≤lout≤800mA			
		TX1117C-3.3	6	24	mV
		Vin =4.8V, 10mA≤lout≤800mA			
		TX1117C-5.0	9	36	mV
		Vin =6.5V, 10mA≤lout≤800mA			
Vdrop	Dropout voltage	lout =100mA	1.2	1.3	V
		lout=800mA	1.3	1.5	V
Imin	Minimum load	TX1117C-ADJ	2	10	mA
	current				
		TX1117C-1.2V,Vin=10V	2	5	mA
		TX1117C-1.8V,Vin=12V	2	5	mA
Iq	Quiescent	TX1117C-2.5V,Vin=12V	2	5	mA
	Current	TX1117C-2.85V,Vin=12V	2	5	mA
		TX1117C-3.3V,Vin=12V	2	5	mA
		TX1117C-5.0V,Vin=12V	2	5	mA
lAdj	Adjust pin	TX1117C-ADJ	55	120	uA
	current	Vin=5V,10mA≤lout≤800mA			
Ichange	ladj change	TX1117C-ADJ	0.2	10	uA
		Vin=5V,10mA≤lout≤800mA			
Δ V/ Δ T	Temperature		±100		ppm
	coefficien				
Α	Thermal	SOT-223	20		
θ JC	resistance	TO-252	10		°C/W

Note1: All test are conducted under ambient temperature 25 $^{\circ}\,$ C and within a short period of time 20ms

Note2: Load current smaller than minimum load current of TX1117C-ADJ will lead to unstable or oscillation output.

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TX1117C

800mA Bipolar Linear Regulator

Detailed Description

TX1117C is a series of low dropout voltage, three terminal regulators. Its application circuit is very simple: the fixed version only needs two capacitors and the adjustable version only needs two resistors and two capacitors to work. It is composed of some modules including start-up circuit, bias circuit, bandgap, thermal shutdown, power transistors and its driver circuit and so on.

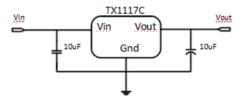
The thermal shut down modules can assure chip and its application system working safety when the junction temperature is larger than 140°C.

The bandgap module provides stable reference voltage, whose temperature coefficient is compensated by careful design considerations. The temperature coefficient is under 100 ppm/°C. And the accuracy of output voltage is guaranteed by trimming technique.

Typical Application

TX1117C has an adjustable version and six fixed versions (1.2V, 1.8V, 2.5V, 2.85V, 3.3V and 5V)

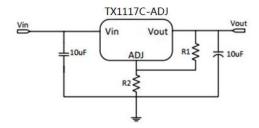
Fixed Output Voltage Version



Application circuit of TX1117C fixed version

- 1) Recommend using 10uF tan capacitor as bypass capacitor (C1) for all application circuit.
- 2) Recommend using 10uF tan capacitor to assure circuit stability.

Adjustable Output Voltage Version



Application Circuit of TX1117C-ADJ

The output voltage of adjustable version follows the equation: Vout= $1.25 \times (1+R2/R1)+IAdj \times R2$. We can ignore IAdj because IAdj (about 50uA) is much less than the current of R1 (about 2~10mA).

- 1) To meet the minimum load current (>10mA) requirement, R1 is recommended to be 125ohm or lower. As TX1117C-ADJ can keep itself stable at load current about 2mA, R1 is not allowed to be higher than 625ohm.
- 2) Using a bypass capacitor (C_{ADJ}) between the ADJ pin and ground can improve ripple rejection. This bypass capacitor prevents ripple from being amplified as the output voltage is increased. The impedance of C_{ADJ} should be less than R1 to prevent ripple from being amplified. As R1 is normally in the range of $100\Omega\sim500\Omega$, the value of C_{ADJ} should satisfy this equation: $1/(2 \pi \times f_{flpple} \times C_{ADJ}) < R1$.



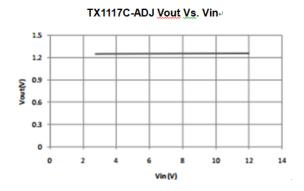
Thermal Considerations

We have to take heat dissipation into great consideration when output current or differential voltage of input and output voltage is large. Because in such cases, the power dissipation consumed by TX1117C is very large. TX1117C series uses SOT-223 package type and its thermal resistance is about 20°C/W. And the copper area of application board can affect the total thermal resistance. If copper area is 5cm*5cm (two sides), the resistance is about 30°C/W. So the total thermal resistance is about 20°C/W + 30°C/W. We can decrease total thermal resistance by increasing copper area in application board. When there is no good heat dissipation copper are in PCB, the total thermal resistance will be as high as 120°C/W, then the power dissipation of TX1117C could allow on itself is less than 1W. And furthermore, TX1117C will work at junction temperature higher than 125°C under such condition and no lifetime is guaranteed.

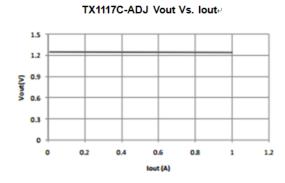
Typical Performance Charcteristics

T_A=25°C, unless otherwise noted.

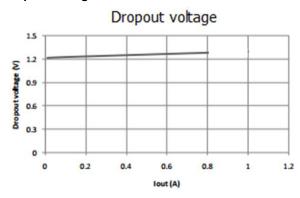
Line regulation



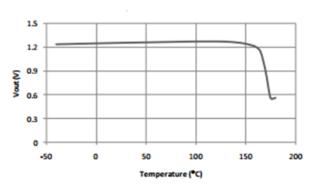
Load regulation



Dropout voltage



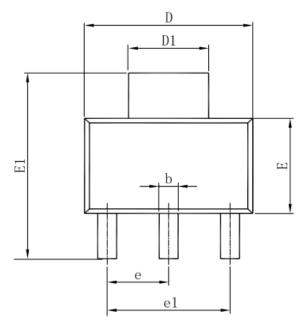
Thermal performance with OTP

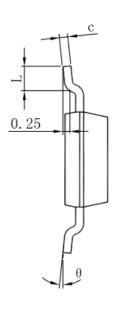


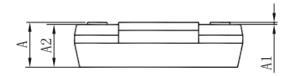


Package Information

SOT-223 PACKAGE OUTLINE DIMENSIONS





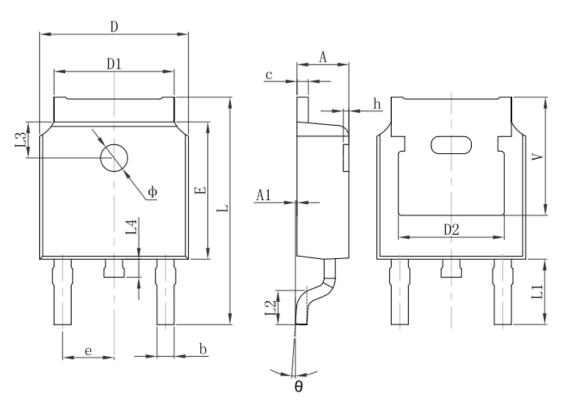




C. mb a l	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.520	1.800	0.060	0.071	
A1	0.000	0.100	0.000	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.820	0.026	0.032	
С	0.250	0.350	0.010	0.014	
D	6.200	6.400	0.244	0.252	
D1	2.900	3.100	0.114	0.122	
E	3.300	3.700	0.130	0.146	
E1	6.830	7.070	0.269	0.278	
е	2.300(BSC)		0.091(BSC)	
e1	4.500	4.700	0.177	0.185	
L	0.900	1.150	0.035	0.045	
θ	0°	10°	0°	10°	



TO-252-2L PACKAGE OUTLINE DIMENSIONS



Cumbal	Dimensions In Millimeters		Dimension	s In Inches	
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	REF.	0.190	REF.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 REF.		0.114	REF.	
L2	1.400	1.700	0.055	0.067	
L3	1.600 REF.		0.063	REF.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	REF.	0.211 REF.		